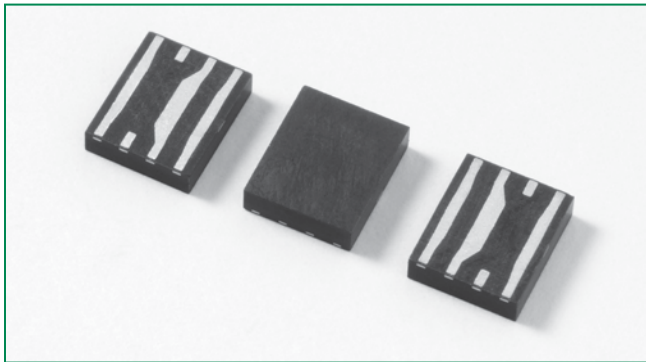


SEP Biased Series - 5x6 QFN



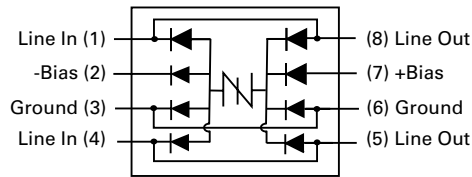
Agency Approvals

| Agency | Agency File Number |
|--------|--------------------|
| | E133083 |

Pinout Designation

| | | | |
|---------|---|---|----------|
| Line in | 1 | 8 | Line out |
| - Bias | 2 | 7 | + Bias |
| Ground | 3 | 6 | Ground |
| Line in | 4 | 5 | Line out |

Schematic Symbol



Additional Information



Datashheet



Resources



Samples

Electrical Characteristics

| Part Number | Marking | $V_{DRM} @ I_{DRM}=5\mu A$ | $V_S @ 100V/\mu s$ | I_H | I_S | $I_T @ V_T$ | $V_T @ I_T=2.2Amps$ | Capacitance |
|--------------|---------|----------------------------|--------------------|--------|--------|-------------|---------------------|--|
| | | V min | V max | mA min | mA max | A max | V max | |
| SEP0080Q38CB | SEP-8C | 6 | 25 | 50 | 800 | 2.2 | 8 | See Capacitance vs. Bias Voltage Graph |
| SEP0640Q38CB | SEP06C | 58 | 77 | 150 | 800 | 2.2 | 8 | |
| SEP0720Q38CB | SEP07C | 65 | 88 | 150 | 800 | 2.2 | 8 | |
| SEP0900Q38CB | SEP09C | 75 | 98 | 150 | 800 | 2.2 | 8 | |
| SEP0080Q38BB | SEP-8B | 6 | 25 | 50 | 800 | 2.2 | 8 | |
| SEP0640Q38BB | SEP06B | 58 | 77 | 150 | 800 | 2.2 | 8 | |
| SEP0720Q38BB | SEP07B | 65 | 88 | 150 | 800 | 2.2 | 8 | |
| SEP0900Q38BB | SEP09B | 75 | 98 | 150 | 800 | 2.2 | 8 | |

Notes:
- Absolute maximum ratings measured at $T_A = 25^\circ C$ (unless otherwise noted).
- Components are bidirectional (unless otherwise noted).

Description

The new SEP (SIDACtor Thyristor Ethernet/PoE Protector) series has a surge rating compatible with GR1089 inter-building and ITU K.20/21 Enhanced protection requirements. Targeted for high-speed applications such as 10BaseT, 100BaseT, and 1000BaseT, the SEP series maintains signal quality while providing robust protection for Ethernet and PoE applications. This latest silicon design innovation results in a capacitive loading characteristic that is constant with respect to the voltage across the component. This reduces distortion caused by typical solid-state protection solutions. Offered in a surface-mount, QFN package, the SEP provides small package size without sacrificing power and surge handling capabilities.

Features & Benefits

- Compatible with 1000Base-T
- Balanced overvoltage protection
- Low distortion
- Low insertion loss
- Low profile
- SO-8 footprint compatible
- Fails short circuit when surged in excess of ratings
- RoHS Compliant and Halogen-Free
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Applicable Global Standards

- TIA-968-A
- TIA-968-B
- ITU K.20/21 Enhanced Level
- ITU K.20/21 Basic Level
- IEC 61000-4-5 2nd edition
- GR 1089 Inter-building
- GR 1089 Intra-building
- YD/T 1082
- YD/T 993
- YD/T 950
- Class 4/5 compliance of IEC 61000-4-5

50/60 Hz Ratings

| Parameter Name | Test Conditions | Value | Units |
|---|-----------------|-------|-------|
| I_{TSM} Maximum non-repetitive on-state current, 50/60 Hz | 0.5s | 6.5 | A |
| | 1s | 4.6 | |
| | 2s | 3.4 | |
| | 5s | 2.3 | |
| | 30s | 1.3 | |
| | 900s | 0.73 | |

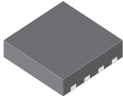
Surge Ratings

| Series | I_{PP} | | | | I_{TSM} |
|--------|--------------|-----------------------------|----------------------|-----------------|-----------------------------|
| | 2x10 μ s | 1.2/50 μ s-8/20 μ s | 10/700-5/310 μ s | 10x1000 μ s | 600V _{RMS} 1 cycle |
| | A min | A min | A min | A min | A _{RMS} |
| B | 250 | 250 | 100 | 80 | 30 |
| C | 500 | 430 | 200 | 100 | 30 |

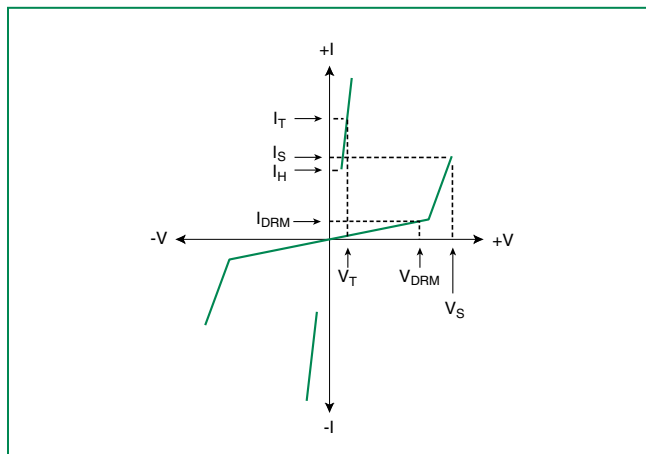
Notes:

- Peak pulse current rating (I_{PP}) is repetitive and guaranteed for the life of the product as long as it returns to 25°C between surges
- I_{PP} ratings applicable over temperature range of -40°C to +85°C
- The components must initially be in thermal equilibrium with -40°C $\leq T_J \leq$ +150°C

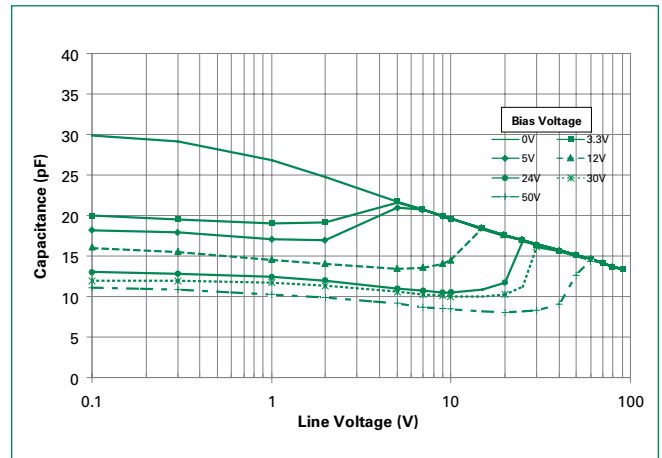
Thermal Considerations

| Package | Symbol | Parameter | Value | Unit |
|--|-----------------|---|-------------|------|
|  5x6 QFN | T_J | Junction Temperature | -40 to +150 | °C |
| | T_{STG} | Storage Temperature Range | -40 to +150 | °C |
| | $R_{\theta JA}$ | Thermal Resistance: Junction to Ambient | 100 | °C/W |

V-I Characteristics

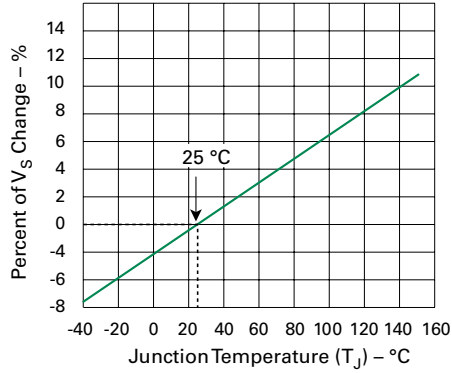


Capacitance vs. Bias Voltage*

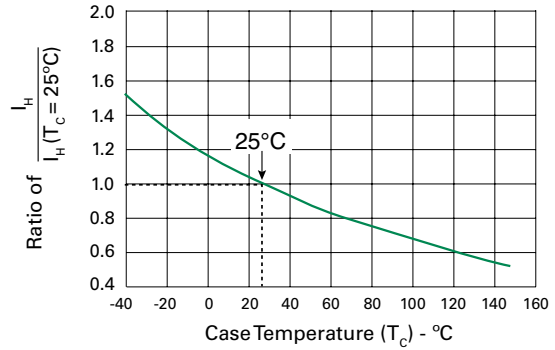


* Bias voltage must be lower than V_{DRM}

Normalized V_s Change vs. Junction Temperature

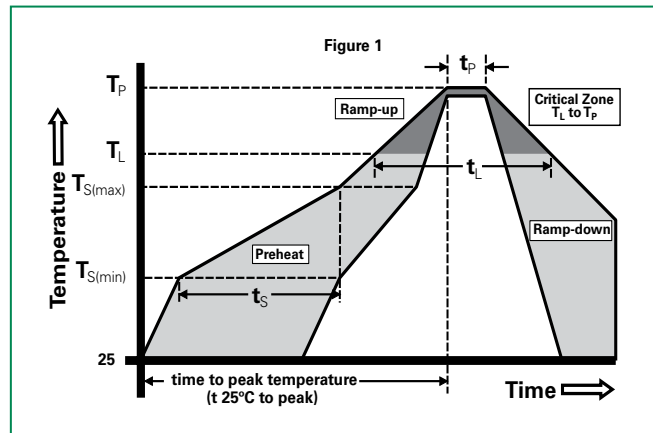


Normalized DC Holding Current vs. Case Temperature



Soldering Parameters

| | | |
|--|------------------------------------|-------------------------------|
| Reflow Condition | | Pb-Free assembly (see Fig. 1) |
| Pre Heat | - Temperature Min ($T_{s(min)}$) | +150°C |
| | - Temperature Max ($T_{s(max)}$) | +200°C |
| | - Time (Min to Max) (t_s) | 60-180 secs. |
| Average ramp up rate (Liquidus Temp (T_L) to peak) | | 3°C/sec. Max. |
| $T_{s(max)}$ to T_L - Ramp-up Rate | | 3°C/sec. Max. |
| Reflow | - Temperature (T_L) (Liquidus) | +217°C |
| | - Temperature (t_L) | 60-150 secs. |
| Peak Temp (T_p) | | +260(+0/-5)°C |
| Time within 5°C of actual Peak Temp (t_p) | | 30 secs. Max. |
| Ramp-down Rate | | 6°C/sec. Max. |
| Time 25°C to Peak Temp (T_p) | | 8 min. Max. |
| Do not exceed | | +260°C |



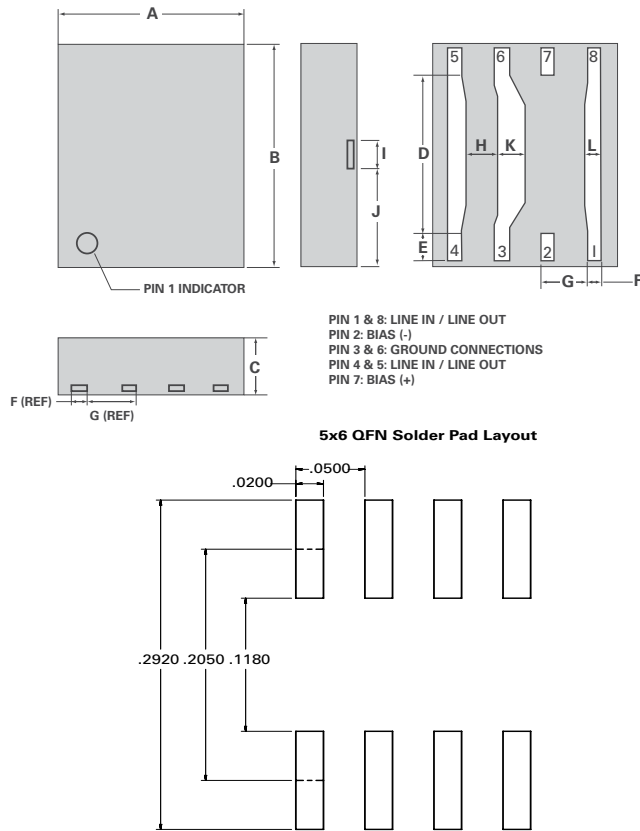
Physical Specifications

| | |
|------------------------|--|
| Lead Material | Copper Alloy |
| Terminal Finish | 100% Matte-Tin Plated |
| Body Material | UL Recognized compound meeting flammability rating V-0 |

Environmental Specifications

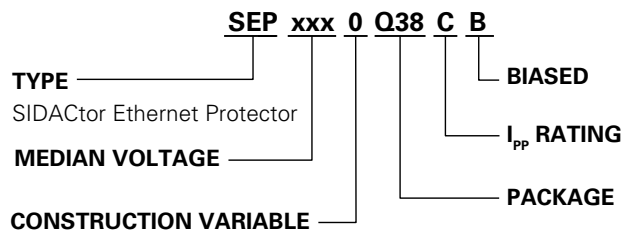
| | |
|-----------------------------------|--|
| High Temp Voltage Blocking | 80% Rated V_{DRM} ($V_{AC Peak}$) +125°C or +150°C, 504 or 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101 |
| Temp Cycling | -65°C to +150°C, 15 min. dwell, 10 up to 100 cycles. MIL-STD-750 (Method 1051) EIA/JEDEC, JESD22-A104 |
| Biased Temp & Humidity | 52 V_{DC} (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101 |
| High Temp Storage | +150°C 1008 hrs. MIL-STD-750 (Method 1031) JEDEC, JESD22-A-101 |
| Low Temp Storage | -65°C, 1008 hrs. |
| Thermal Shock | 0°C to +100°C, 5 min. dwell, 10 sec. transfer, 10 cycles. MIL-STD-750 (Method 1056) JEDEC, JESD22-A-106 |
| Resistance to Solder Heat | +260°C, 30 secs. MIL-STD-750 (Method 2031) |
| Moisture Sensitivity Level | 85%RH, +85°C, 168 hrs., 3 reflow cycles (+260°C Peak). JEDEC-J-STD-020, Level 1 |

Dimensions — 5x6 QFN

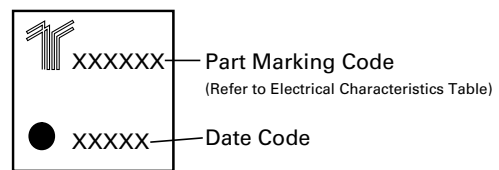


| Dimension | Inches | | Millimeters | |
|-----------|--------|-------|-------------|-------|
| | Min | Max | Min | Max |
| A | 0.187 | 0.207 | 4.745 | 5.253 |
| B | 0.226 | 0.246 | 5.745 | 6.253 |
| C | 0.054 | 0.064 | 1.374 | 1.628 |
| D | 0.165 | 0.171 | 4.199 | 4.351 |
| E | 0.027 | 0.033 | 0.686 | 0.838 |
| F | 0.011 | 0.017 | 0.279 | 0.432 |
| G | 0.047 | 0.053 | 1.194 | 1.346 |
| H | 0.032 | 0.038 | 0.800 | 0.953 |
| I | 0.027 | 0.033 | 0.686 | 0.838 |
| J | 0.100 | 0.106 | 2.540 | 2.692 |
| K | 0.027 | 0.033 | 0.686 | 0.838 |
| L | 0.015 | 0.021 | 0.381 | 0.533 |

Part Numbering



Part Marking

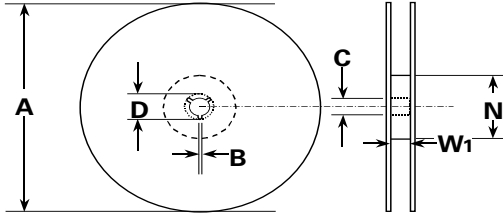


Packing Options

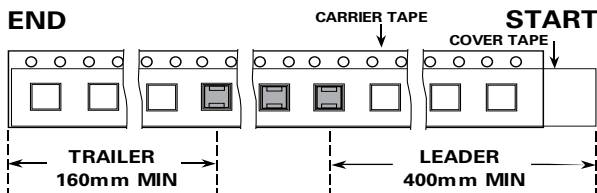
| Package Type | Description | Quantity | Added Suffix | Industry Standard |
|--------------|------------------------------|----------|--------------|-------------------|
| Q38 | 5x6x1.5 QFN Tape and Reel | 4,000 | N / A | EIA-481-D |

Tape and Reel Specifications — 5x6 QFN

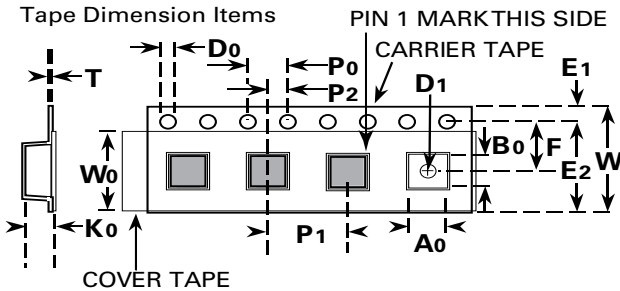
Reel Dimension



Tape Leader and Trailer Dimensions



Tape Dimension Items



| Symbols | Description | Inches | | Millimeters | |
|----------------|---|--------|--------|-------------|-------|
| | | Min | Max | Min | Max |
| A | Reel Diameter | N/A | 12.992 | N/A | 330.0 |
| B | Drive Spoke Width | 0.059 | N/A | 1.50 | N/A |
| C | Arbor Hole Diameter | 0.504 | 0.531 | 12.80 | 13.50 |
| D | Drive Spoke Diameter | 0.795 | N/A | 20.20 | N/A |
| N | Hub Diameter | 1.969 | N/A | 50.00 | N/A |
| W ₁ | Reel Inner Width at Hub | 0.488 | 0.567 | 12.40 | 14.40 |
| A ₀ | Pocket Width at Bottom | 0.204 | 0.212 | 5.20 | 5.40 |
| B ₀ | Pocket Length at Bottom | 0.244 | 0.252 | 6.20 | 6.40 |
| D ₀ | Feed Hole Diameter | 0.059 | 0.063 | 1.50 | 1.60 |
| D ₁ | Pocket Hole Diameter | 0.059 | N/A | 1.50 | N/A |
| E ₁ | Feed Hole Position 1 | 0.065 | 0.073 | 1.65 | 1.85 |
| E ₂ | Feed Hole Position 2 | 0.400 | 0.408 | 10.15 | 10.35 |
| F | Feed Hole Center - Pocket Hole Center 2 | 0.212 | 0.220 | 5.40 | 5.60 |
| K ₀ | Pocket Depth | 0.067 | 0.075 | 1.70 | 1.90 |
| P ₀ | Feed Hole Pitch | 0.153 | 0.161 | 3.90 | 4.10 |
| P ₁ | Component Spacing | 0.311 | 0.319 | 7.90 | 8.10 |
| P ₂ | Feed Hole Center - Pocket Hole Center 1 | 0.077 | 0.081 | 1.90 | 2.10 |
| T | Carrier Tape Thickness | 0.010 | 0.014 | 0.25 | 0.35 |
| W | Embossed Carrier Tape Width | 0.460 | 0.484 | 11.70 | 12.30 |
| W ₀ | Cover Tape Width | 0.358 | 0.366 | 9.10 | 9.30 |

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